74LVC4245A

Octal dual supply translating transceiver; 3-state Rev. 10 — 18 December 2012 Pro-

Product data sheet

General description 1.

The 74LVC4245A is an octal dual supply translating transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions. It is designed to interface between a 3 V and 5 V bus in a mixed 3 V and 5 V supply environment.

The device features an output enable input (pin OE) for easy cascading and a send/receive input (pin DIR) for direction control. Pin OE controls the outputs so that the buses are effectively isolated.

In suspend mode, when $V_{\rm CC(A)}$ is zero, there will be no current flow from one supply to the other supply. The A-outputs must be set 3-state and the voltage on the A-bus must be smaller than V_{diode} (typical 0.7 V).

 $V_{CC(A)} \ge V_{CC(B)}$, except in suspend mode.

2. **Features and benefits**

- 5 V tolerant inputs/outputs, for interfacing with 5 V logic
- Wide supply voltage range:
 - ◆ 3 V bus (V_{CC(B)}): 1.5 V to 3.6 V
 - 5 V bus (V_{CC(A)}): 1.5 V to 5.5 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Inputs accept voltages up to 5.5 V
- High-impedance when V_{CC(A)} = 0 V
- Complies with JEDEC standard no. JESD8B/JESD36
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



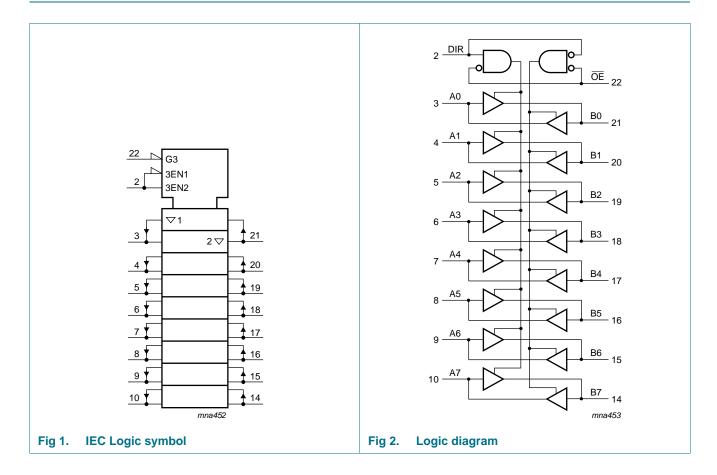
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3. Ordering information

Table 1. Ordering information

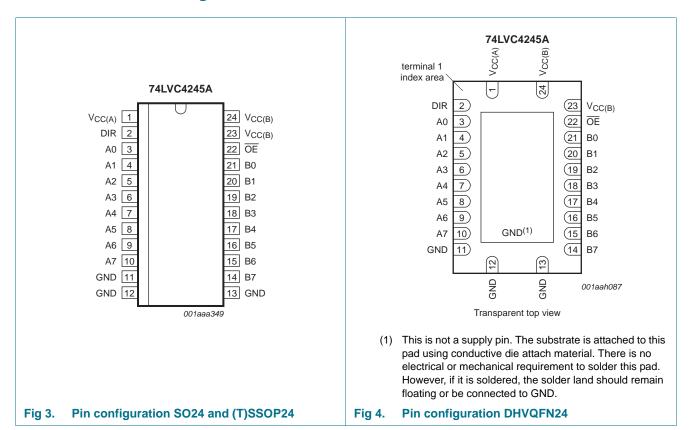
Type number	Package	Package							
	Temperature range	Name	Description	Version					
74LVC4245AD	–40 °C to +125 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1					
74LVC4245ADB	–40 °C to +125 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1					
74LVC4245APW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1					
74LVC4245ABQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5\times5.5\times0.85$ mm	SOT815-1					

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
$V_{CC(A)}$	1	supply voltage (5 V bus)
V _{CC(B)}	23, 24	supply voltage (3 V bus)
GND	11, 12, 13	ground (0 V)
DIR	2	direction control
A[0:7]	3, 4, 5, 6, 7, 8, 9, 10	data input or output
B[0:7]	21, 20, 19, 18, 17, 16, 15, 14	data input or output
ŌE	22	output enable input (active LOW)

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6. Functional description

Table 3. Functional table[1]

Input		Input/output			
OE	E DIR		Bn		
L	L	A = B	input		
L	Н	input	B = A		
Н	X	Z	Z		

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				_	
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC(A)}$	supply voltage A		-0.5	+6.5	V
$V_{CC(B)}$	supply voltage B		-0.5	+4.6	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
V _I	input voltage		<u>[1]</u> -0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CCO}$ or $V_O < 0 \text{ V}$	[3] _	±50	mA
V _O	output voltage	output HIGH or LOW state	<u>[1]</u> -0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[1]</u> -0.5	+6.5	V
I _O	output current	$V_O = 0 V \text{ to } V_{CCO}$	<u>[3]</u> _	±50	mA
I _{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2] _	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC(A)}	supply voltage A	$V_{CC(A)} \ge V_{CC(B)}$; see Figure 5 for maximum speed performance	1.5	-	5.5	V
V _{CC(B)}	supply voltage B	$V_{CC(A)} \ge V_{CC(B)}$; see Figure 5 for low-voltage applications	1.5	-	3.6	V
VI	input voltage	for control inputs	0	-	5.5	V

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^[2] For SO24 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For (T)SSOP24 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. For DHVQFN24 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

^[3] V_{CCO} is the supply voltage associated with the output.

 Table 5.
 Recommended operating conditions ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{O}	output voltage	output HIGH or LOW state	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC(B)} = 2.7 \text{ V to } 3.0 \text{ V}$	-	-	20	ns/V
		$V_{CC(B)} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	10	ns/V
		$V_{CC(A)} = 3.0 \text{ V to } 4.5 \text{ V}$	-	-	20	ns/V
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$T_{amb} = -4$	0 °C to +85 °C					
V_{IH}	HIGH-level input voltage	$V_{CC(B)} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$	2.0	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC(B)} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	V
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	0.8	V
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$V_{CC(B)}$ = 2.7 V to 3.6 V; I_O = -100 μA	$V_{CC(B)} - 0.2$	V _{CC(B})	-	V
		$V_{CC(B)} = 2.7 \text{ V}; I_O = -12 \text{ mA}$	$V_{CC(B)} - 0.5$	-	-	V
		$V_{CC(B)} = 3.0 \text{ V}; I_{O} = -24 \text{ mA}$	$V_{CC(B)} - 0.8$	-	-	V
		$V_{CC(A)}$ = 4.5 V to 5.5 V; I_O = $-100~\mu A$	$V_{CC(A)} - 0.2$	V _{CC(A})	-	V
		$V_{CC(A)} = 4.5 \text{ V}; I_O = -12 \text{ mA}$	$V_{CC(A)} - 0.5$	-	-	V
		$V_{CC(A)} = 4.5 \text{ V}; I_O = -24 \text{ mA}$	$V_{CC(A)} - 0.8$	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$V_{CC(B)}$ = 2.7 V to 3.6 V; I_O = 100 μA	-	-	0.20	V
		$V_{CC(B)} = 2.7 \text{ V}; I_O = 12 \text{ mA}$	-	-	0.40	V
		$V_{CC(B)} = 3.0 \text{ V}; I_O = 24 \text{ mA}$	-	-	0.55	V
		$V_{CC(A)}$ = 4.5 V to 5.5 V; I_O = 100 μA	-	-	0.20	V
		$V_{CC(A)} = 4.5 \text{ V}; I_O = 12 \text{ mA}$	-	-	0.40	V
		$V_{CC(A)} = 4.5 \text{ V}; I_O = 24 \text{ mA}$	-	-	0.55	V
I _I	input leakage current	$V_I = 5.5 \text{ V or GND}$	-	±0.1	±5	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL}	<u>[2]</u>			
		$V_{CC(B)} = 3.6 \text{ V}; V_O = V_{CC(B)} \text{ or GND}$	-	±0.1	±5	μΑ
		$V_{CC(A)} = 5.5 \text{ V}; V_O = V_{CC(A)} \text{ or GND}$	-	±0.1	±5	μΑ
I _{CC}	supply current	I _O = 0 A				
		$V_{CC(B)} = 3.6 \text{ V};$ other inputs at $V_{CC(B)}$ or GND	-	0.1	10	μА
		$V_{CC(A)} = 5.5 \text{ V};$ other inputs at $V_{CC(A)}$ or GND	-	0.1	10	μΑ

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Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
ΔI_{CC}	additional supply current	per control pin; I _O = 0 A	[3]			
		$V_{CC(B)}$ = 2.7 V to 3.6 V; V_1 = $V_{CC(B)}$ – 0.6 V; other inputs at $V_{CC(B)}$ or GND	-	5	500	μА
		$V_{CC(A)}$ = 4.5 V to 5.5 V; V_I = $V_{CC(A)}$ – 0.6 V; other inputs at $V_{CC(A)}$ or GND	-	5	500	μΑ
Cı	input capacitance		-	4.0	-	pF
C _{I/O}	input/output capacitance	An and Bn	-	5.0	-	pF
T _{amb} = -4	0 °C to +125 °C					
V_{IH}	HIGH-level input voltage	$V_{CC(B)} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
		V _{CC(A)} = 4.5 V to 5.5 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC(B)} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	V
		V _{CC(A)} = 4.5 V to 5.5 V	-	-	0.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$V_{CC(B)}$ = 2.7 V to 3.6 V; I_O = -100 μA	$V_{CC(B)}-0.3$	-	-	V
		$V_{CC(B)} = 2.7 \text{ V}; I_O = -12 \text{ mA}$	$V_{CC(B)} - 0.65$	-	-	V
		$V_{CC(B)} = 3.0 \text{ V}; I_O = -24 \text{ mA}$	$V_{CC(B)} - 1.0$	-	-	V
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V; } I_O = -100 \mu\text{A}$	$V_{CC(A)} - 0.3$	-	-	V
		$V_{CC(A)} = 4.5 \text{ V}; I_O = -12 \text{ mA}$	$V_{CC(A)} - 0.65$	-	-	V
		$V_{CC(A)} = 4.5 \text{ V}; I_O = -24 \text{ mA}$	$V_{CC(A)} - 1.0$	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$V_{CC(B)}$ = 2.7 V to 3.6 V; I_O = 100 μA	-	-	0.30	V
		$V_{CC(B)} = 2.7 \text{ V}; I_O = 12 \text{ mA}$	-	-	0.60	V
		$V_{CC(B)} = 3.0 \text{ V}; I_O = 24 \text{ mA}$	-	-	0.80	V
		$V_{CC(A)}$ = 4.5 V to 5.5 V; I_O = 100 μA	-	-	0.30	V
		$V_{CC(A)} = 4.5 \text{ V}; I_O = 12 \text{ mA}$	-	-	0.60	V
		$V_{CC(A)} = 4.5 \text{ V}; I_O = 24 \text{ mA}$	-	-	0.80	V
II	input leakage current	$V_I = 5.5 \text{ V or GND}$	-	-	±20	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL}	[2]			
		$V_{CC(B)} = 3.6 \text{ V}; V_O = V_{CC(B)} \text{ or GND}$	-	-	±20	μΑ
		$V_{CC(A)} = 5.5 \text{ V}; V_O = V_{CC(A)} \text{ or GND}$	-	-	±20	μΑ
I _{CC}	supply current	$I_O = 0 A$				
		$V_{CC(B)} = 3.6 \text{ V};$ other inputs at $V_{CC(B)}$ or GND	-	-	40	μΑ
		$V_{CC(A)} = 5.5 \text{ V};$ other inputs at $V_{CC(A)}$ or GND	-	-	40	μΑ

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 Table 6.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
ΔI_{CC}	additional supply current	per control pin; I _O = 0 A	<u>[3]</u>			
		$V_{CC(B)}$ = 2.7 V to 3.6 V; V_I = $V_{CC(B)}$ – 0.6 V; other inputs at $V_{CC(B)}$ or GND	-	-	5000	μΑ
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V};$ $V_I = V_{CC(A)} - 0.6 \text{ V};$ other inputs at $V_{CC(A)}$ or GND	-	-	5000	μА

^[1] All typical values are measured at $V_{CC(A)} = 5.0 \text{ V}$, $V_{CC(B)} = 3.3 \text{ V}$ and $T_{amb} = 25 \,^{\circ}\text{C}$.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). $V_{CC(A)} = 4.5 \text{ V}$ to 5.5 V; $t_r = t_f \le 2.5 \text{ ns}$. For test circuit see <u>Figure 8</u>.

Symbol	Parameter	Conditions	V _{CC(B})	-40	°C to +8	5 °C	-40 °C to	-40 °C to +125 °C	
				Min	Typ[1]	Max	Min	Max	
t _{PHL}	HIGH to LOW	An to Bn;	2.7 V	1.0	3.6	6.3	1.0	8.0	ns
	propagation	see Figure 6	3.0 V to 3.6 V	1.0	3.3	6.3	1.0	8.0	ns
	delay	Bn to An;	2.7 V	1.0	3.4	6.1	1.0	8.0	ns
		see Figure 6	3.0 V to 3.6 V	1.0	3.4	6.1	1.0	8.0	ns
t _{PLH}	LOW to HIGH	An to Bn;	2.7 V	1.0	3.3	6.7	1.0	8.5	ns
	propagation	see Figure 6	3.0 V to 3.6 V	1.0	2.8	6.5	1.0	8.5	ns
	delay	Bn to An;	2.7 V	1.0	3.0	5.0	1.0	6.5	ns
		see Figure 6	3.0 V to 3.6 V	1.0	3.0	5.0	1.0	6.5	ns
t _{PZL} OFF-state to LOW propagation delay	OE to An;	2.7 V	1.0	4.5	9.0	1.0	11.5	ns	
	see Figure 7	3.0 V to 3.6 V	1.0	4.5	9.0	1.0	11.5	ns	
	delay	OE to Bn;	2.7 V	1.0	4.4	8.7	1.0	11.0	ns
		see Figure 7	3.0 V to 3.6 V	1.0	3.8	8.1	1.0	10.5	ns
t _{PZH}	OFF-state to	OE to An;	2.7 V	1.0	4.5	8.1	1.0	10.5	ns
	HIGH	see Figure 7	3.0 V to 3.6 V	1.0	4.5	8.1	1.0	10.5	ns
	propagation delay	OE to Bn;	2.7 V	1.0	4.3	8.7	1.0	11.0	ns
	•	see Figure 7	3.0 V to 3.6 V	1.0	3.2	8.1	1.0	10.5	ns
t _{PLZ}	LOW to	OE to An;	2.7 V	1.0	2.9	7.0	1.0	9.0	ns
	OFF-state	see Figure 7	3.0 V to 3.6 V	1.0	2.9	7.0	1.0	9.0	ns
	propagation delay	OE to Bn;	2.7 V	1.0	3.9	7.7	1.0	10.0	ns
	•	see Figure 7	3.0 V to 3.6 V	1.0	3.5	7.7	1.0	10.0	ns
t _{PHZ}	HIGH to	OE to An;	2.7 V	1.0	2.8	5.8	1.0	7.5	ns
	OFF-state	see Figure 7	3.0 V to 3.6 V	1.0	2.8	5.8	1.0	7.5	ns
	propagation delay	OE to Bn;	2.7 V	1.0	3.3	7.8	1.0	10.0	ns
	- ,	see Figure 7	3.0 V to 3.6 V	1.0	2.9	7.8	1.0	10.0	ns
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^[2] For transceivers, the parameter I_{OZ} includes the input leakage current.

^[3] $V_{CC(B)} = 2.7$ V to 3.6 V: other inputs at $V_{CC(B)}$ or GND. $V_{CC(A)} = 4.5$ V to 5.5 V: other inputs at $V_{CC(A)}$ or GND.

Octal dual supply translating transceiver; 3-state

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). $V_{CC(A)} = 4.5 \text{ V}$ to 5.5 V; $t_r = t_f \le 2.5 \text{ ns}$. For test circuit see Figure 8.

Symbol	Parameter	Conditions	V _{CC(B})	-40	-40 °C to +85 °C			-40 °C to +125 °C	
				Min	Typ[1]	Max	Min	Max	
$t_{sk(o)}$	output skew time		<u>[2]</u>	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation capacitance	5 V bus: Bn to An; $V_I = GND$ to $V_{CC(A)}$; $V_{CC(A)} = 5.0 \text{ V}$	[3]						
		outputs enabled	-	-	17	-	-	-	pF
		outputs disabled	-	-	5	-	-	-	pF
		3 V bus: An to Bn; $V_I = GND$ to $V_{CC(B)}$; $V_{CC(B)} = 3.3 \text{ V}$	[3]						
		outputs enabled	-	-	17	-	-	-	pF
		outputs disabled	-	-	5	-	-	-	pF

^[1] Typical values are measured at T_{amb} = 25 °C, $V_{CC(A)}$ = 5.0 V, and $V_{CC(B)}$ = 2.7 V and 3.3 V respectively.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz; f_o = output frequency in MHz

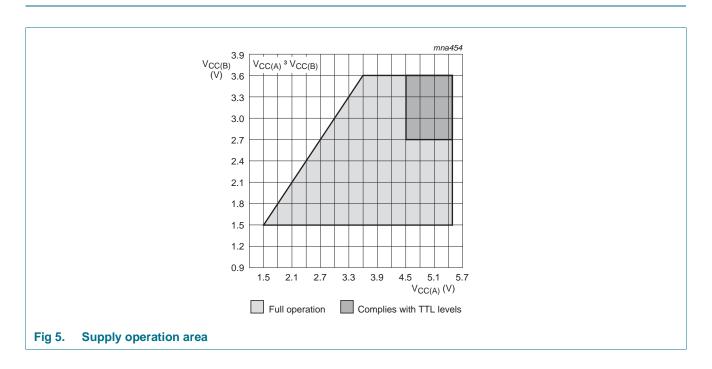
C_L = output load capacitance in pF

 V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

11. AC waveforms



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^[2] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

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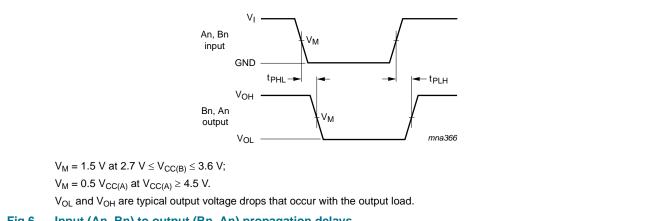
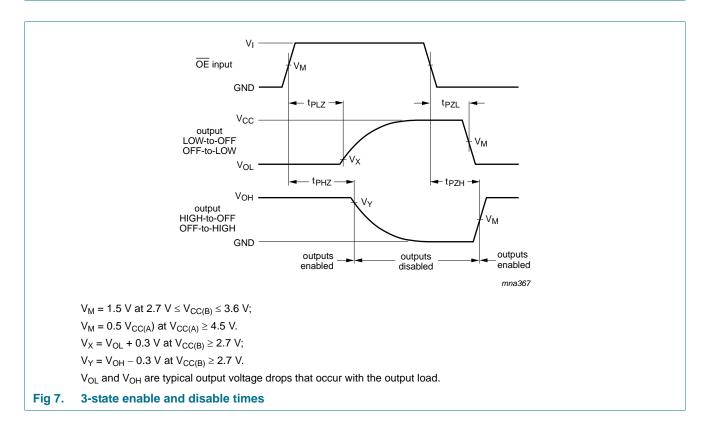
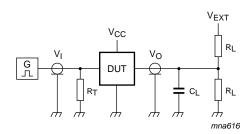


Fig 6. Input (An, Bn) to output (Bn, An) propagation delays



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Test data is given in Table 8. Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

Fig 8. Load circuitry for switching times

Table 8. Test data

Supply voltage		Input	Load	Load		V _{EXT}		
V _{CC(A)}	V _{CC(B)}	V _I [1]	CL	R_L	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [2]	
< 2.7 V	< 2.7 V	V_{CCI}	50 pF	500Ω	open	GND	$2\times V_{CCO}$	
-	2.7 V to 3.6 V	2.7 V	50 pF	500Ω	open	GND	$2 \times V_{CCO}$	
4.5 V to 5.5 V	-	3.0 V	50 pF	500Ω	open	GND	$2 \times V_{CCO}$	

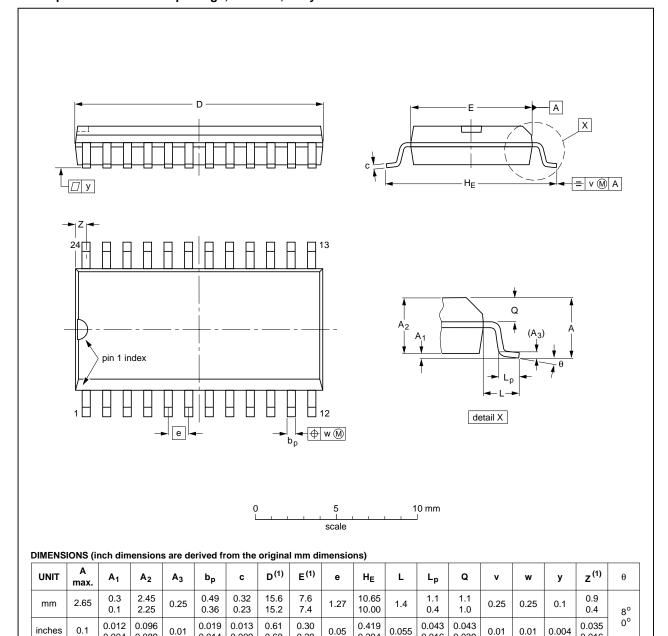
^[1] V_{CCI} is the supply voltage associated with the data input port.

^[2] V_{CCO} is the supply voltage associated with the output port.

12. Package outline

SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.014

0.009

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT137-1	075E05	MS-013			99-12-27 03-02-19	

0.394

0.016

0.039

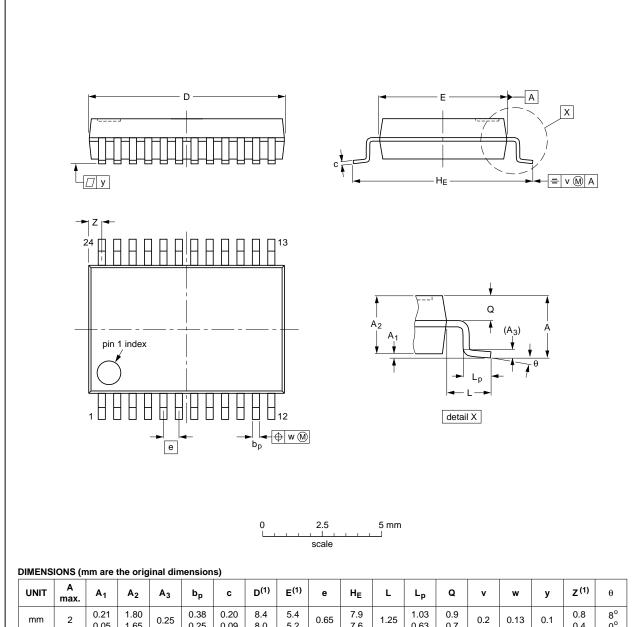
Fig 9. Package outline SOT137-1 (SO24)

0.089

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SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



	(.					,												
UNI	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	8.4 8.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.8 0.4	8° 0°

Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT340-1		MO-150			99-12-27 03-02-19

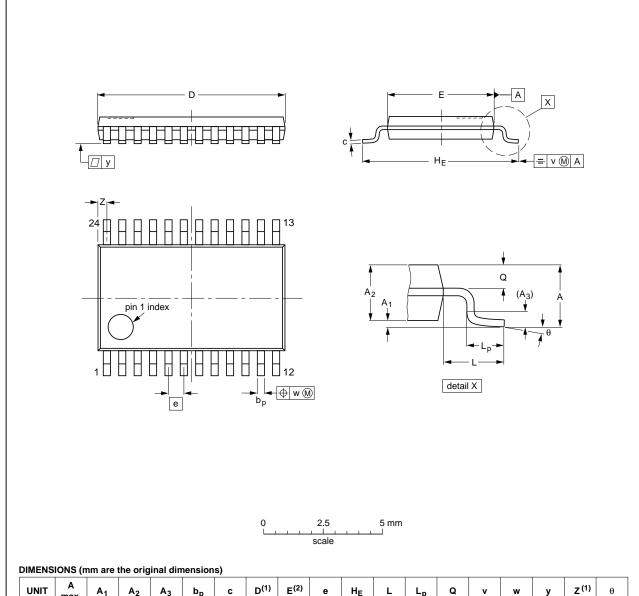
Fig 10. Package outline SOT340-1 (SSOP24)

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TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



- 3							-,												
	UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT355-1		MO-153			99-12-27 03-02-19

Fig 11. Package outline SOT355-1 (TSSOP24)

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm

SOT815-1

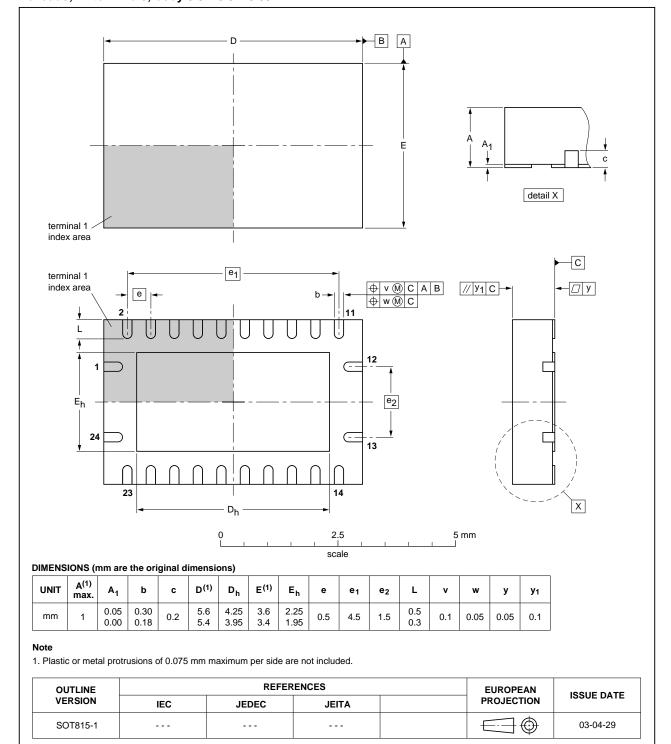


Fig 12. Package outline SOT815-1 (DHVQFN24)

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13. Abbreviations

Table 9. Abbreviations

Acronym	Description
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 10. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC4245A v.10	20121218	Product data sheet	-	74LVC4245A v.9
Modifications:	 V_{CC(A)} and V_{CC} 	$_{C(B)}$ changed into $V_{CC(A)}$ and	d V _{CC(B)} (errata)	
74LVC4245A v.9	20121120	Product data sheet	-	74LVC4245A v.8
Modifications:	• Figure 4: Pin co	onfiguration drawing correc	ted for DHVQFN24 pac	kage
74LVC4245A v.8	20111122	Product data sheet	-	74LVC4245A v.7
74LVC4245A v.7	20110812	Product data sheet	-	74LVC4245A v.6
74LVC4245A v.6	20080118	Product data sheet	-	74LVC4245A v.5
74LVC4245A v.5	20040330	Product specification	-	74LVC4245A v.4
74LVC4245A v.4	20040211	Product specification	-	74LVC4245A v.3
74LVC4245A v.3	19990615	Product specification	-	74LVC4245A v.2
74LVC4245A v.2	19980729	Product specification	-	74LVC4245A v.1
74LVC4245A v.1	19980729	Product specification	-	-

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15. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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